

5th International Workshop on Emerging Technologies for 5G Wireless Cellular Networks

In conjunction with IEEE GLOBECOM 2016, Sunday, December 4, 2016, Washington, DC, USA, <http://wcsp.eng.usf.edu/5g/2016/>

Workshop Chairs	Call for papers																																																																
Wei Yu, University of Toronto, Canada Tommy Svensson, Chalmers U. of Technology, Sweden Lingjia Liu, University of Kansas, USA	<p>The wireless cellular network has been one of the most successful communications technologies of the last three decades. The advent of smartphones and tablets over the past several years has resulted in an explosive growth of data traffic over the cellular network not seen in previous generations. With the proliferation of more smart terminals communicating with servers and each other via broadband wireless networks, numerous new applications have also emerged to take advantage of wireless connectivity. As the fourth generation (4G) networks, namely 3GPP LTE-A, mature and become great commercial success, the research community is now increasingly looking beyond 4G and into future 5G technologies both in standardization body such as 3GPP, and in research programs such as 5GPPP in EU Horizon2020.</p>																																																																
Technical Program Chairs	<p>Fundamental requirements that have emerged for radio access networks in the 2020 and beyond era include: 1) Capabilities for supporting massive capacity and massive connectivity; 2) Support for an increasingly diverse set of services, application and users – all with extremely diverging requirements for work and life; 3) Flexible and efficient use of all available non-contiguous spectrum for wildly different network deployment scenarios. These requirements bring a number of challenges to the design of future wireless networks, including the capability of supporting diverse traffic characteristics, massive connectivity due to massive number of devices (including machine-type terminals), and the densification and heterogeneity of such networks.</p>																																																																
Halim Yanikomeroglu, Carleton University, Canada Charlie (Jianzhong) Zhang, Samsung Electronics, USA Peiyong Zhu, Huawei Technologies, Canada	<p>This workshop will be a venue to brainstorm on and to identify the emerging concepts, technologies, and analytical tools for 5G cellular networks. We aim to bring together leading researchers in both academia and industry, and to provide a forum for researchers from diverse backgrounds to share their views on what 5G should be and to have an open dialogue on the future of wireless research. The goal is to identify key 5G technology drivers that can deliver significant capacity, coverage and user-experience benefits. Topics of interest include, but are not limited to the following:</p>																																																																
Keynote Speakers	<ul style="list-style-type: none"> • Novel radio access network (RAN) architectures <ul style="list-style-type: none"> ○ HetNets with overlay of high- and low-power nodes ○ CoMP (coordinated multi-point) transmission and reception ○ Distributed antenna systems ○ Advanced relaying, user terminal relaying ○ Small cell deployment, femtocells, picocells ○ Terminal intelligence, Context awareness • Advanced radio resource management (RRM) techniques <ul style="list-style-type: none"> ○ Interference management, interference awareness ○ Inter-cell interference coordination (ICIC, eICIC) ○ Artificial intelligence in wireless communications ○ Congestion management • Emerging technologies in physical layer <ul style="list-style-type: none"> ○ Interference-robust air interface ○ Higher-order massive MIMO, Active antenna systems (AAS) ○ Multiuser communications, Network information theory ○ Novel modulation and coding schemes, Waveforms beyond OFDM(A) • Novel services <ul style="list-style-type: none"> ○ Enhanced voice and video, Telepresence ○ Machine-to-machine (M2M), machine-type communications (MTC) ○ Point-to-point (P2P) / device-to-device (D2D) communications • mmWave communications <ul style="list-style-type: none"> ○ Channel characteristics and modeling, Feasibility studies ○ Initial access; Beamforming, beam tracking; Mobility solutions; System design aspects • Energy efficiency <ul style="list-style-type: none"> ○ Energy consumption models ○ Joint RF-baseband optimization; End-to-end energy optimization • Spectrum <ul style="list-style-type: none"> ○ Aggregation of intra and inter-band carriers for both FDD and TDD ○ Cognitive radio and dynamic spectrum access, ○ Adaptive radio access techniques • Prototype and test-bed for emerging 5G technologies 																																																																
Panel Program																																																																	
TBA																																																																	
Technical Program Committee																																																																	
<table border="0"> <tr> <td>Abdulkareem Adinoyi, Carleton University</td> <td>Witold Krzymieñ, University of Alberta / TRILabs</td> </tr> <tr> <td>Raviraj Adve, University of Toronto</td> <td>Michel Kulhandjian, State University of New York at Buffalo</td> </tr> <tr> <td>İbrahim Altunbaş, Istanbul Technical University</td> <td>Yicheng Lin, University of Toronto</td> </tr> <tr> <td>Sergey Andreev, Tampere University of Technology</td> <td>Liang Liu, University of Toronto</td> </tr> <tr> <td>Imran Ansari, Texas A&M University at Qatar (TAMUQ)</td> <td>Liangping Ma, InterDigital</td> </tr> <tr> <td>Erdem Bala, InterDigital</td> <td>Behrooz Makki, Chalmers University of Technology</td> </tr> <tr> <td>Anantharaman Balasubramanian, Interdigital Communications</td> <td>Nicholas Mastronarde, University at Buffalo</td> </tr> <tr> <td>Hadi Baligh, Huawei Technologies Canada co. Ltd.</td> <td>Hani Mehrpouyan, Boise State University</td> </tr> <tr> <td>Federico Boccardi, Ofcom</td> <td>Keivan Navaie, Lancaster University</td> </tr> <tr> <td>Shengrong Bu, University of Glasgow</td> <td>Apostolos Papatthassiou, Intel Corporation</td> </tr> <tr> <td>Daniel Calabuig, Universidad Politecnica de Valencia</td> <td>Nikolaos Pappas, Linköping University</td> </tr> <tr> <td>Houda Chafnaji, INPT Rabat</td> <td>Benoit Pelletier, InterDigital Canada</td> </tr> <tr> <td>Rong-Rong Chen, University of Utah</td> <td>Yinan Qi, Samsung R & D Institute UK</td> </tr> <tr> <td>Runhua Chen, China Academy of Telecomm. Technology</td> <td>Sandra Roger, Universitat Politècnica de València</td> </tr> <tr> <td>Julian Cheng, University of British Columbia</td> <td>Hamid Saeedi, Tarbiat Modares University</td> </tr> <tr> <td>Hayssam Dahrouj, Effat University</td> <td>Karim Seddik, American University in Cairo</td> </tr> <tr> <td>Oussama Damen, University of Waterloo</td> <td>Nima Seifi, Ericsson Research</td> </tr> <tr> <td>Zhiguo Ding, Lancaster University</td> <td>Cong Shen, University of Science and Technology of China</td> </tr> <tr> <td>Qinghe Du, Xi'an Jiaotong University</td> <td>Gokul Sridharan, Rutgers University</td> </tr> <tr> <td>Lutfiye Durak-Ata, Yildiz Technical University</td> <td>Leszek Szczecinski, INRS-EMT</td> </tr> <tr> <td>Salman Durrani, The Australian National University</td> <td>Chintha Tellambura, University of Alberta</td> </tr> <tr> <td>Ozgur Ertug, Gazi University</td> <td>Milos Tesanovic, Samsung Electronics R&D Institute UK</td> </tr> <tr> <td>Carlo Fischione, KTH</td> <td>Antti Tölli, University of Oulu</td> </tr> <tr> <td>Ramy Gohary, Carleton University</td> <td>Stefan Valentin, Huawei Technologies</td> </tr> <tr> <td>David González G, Aalto University</td> <td>Xianbin Wang, University of Western Ontario</td> </tr> <tr> <td>Ekrum Hossain, University of Manitoba</td> <td>Joerg Widmer, IMDEA Networks Institute</td> </tr> <tr> <td>Kianoush Hosseini, Qualcomm Inc.</td> <td>Jingxian Wu, University of Arkansas</td> </tr> <tr> <td>Salama Ikki, Lakehead University</td> <td>Xiaodong Xu, Beijing Univ. of Posts and Telecommunications</td> </tr> <tr> <td>Hazer Inaltekin, Antalya International University</td> <td>Yang Yi, University of Kansas</td> </tr> <tr> <td>Omneya Issa, Communications Research Centre Canada</td> <td>Di Yuan, Linköping University</td> </tr> <tr> <td>Gunes Karabulut Kurt, Istanbul Technical University</td> <td>Wolfgang Zirwas, Nokia Siemens Networks GmbH&CoKG</td> </tr> <tr> <td>Mehmet Kemal Karakayali, Bell Labs, Alcatel-Lucent</td> <td>Yaning Zou, Technische Universität Dresden</td> </tr> </table>	Abdulkareem Adinoyi, Carleton University	Witold Krzymieñ, University of Alberta / TRILabs	Raviraj Adve, University of Toronto	Michel Kulhandjian, State University of New York at Buffalo	İbrahim Altunbaş, Istanbul Technical University	Yicheng Lin, University of Toronto	Sergey Andreev, Tampere University of Technology	Liang Liu, University of Toronto	Imran Ansari, Texas A&M University at Qatar (TAMUQ)	Liangping Ma, InterDigital	Erdem Bala, InterDigital	Behrooz Makki, Chalmers University of Technology	Anantharaman Balasubramanian, Interdigital Communications	Nicholas Mastronarde, University at Buffalo	Hadi Baligh, Huawei Technologies Canada co. Ltd.	Hani Mehrpouyan, Boise State University	Federico Boccardi, Ofcom	Keivan Navaie, Lancaster University	Shengrong Bu, University of Glasgow	Apostolos Papatthassiou, Intel Corporation	Daniel Calabuig, Universidad Politecnica de Valencia	Nikolaos Pappas, Linköping University	Houda Chafnaji, INPT Rabat	Benoit Pelletier, InterDigital Canada	Rong-Rong Chen, University of Utah	Yinan Qi, Samsung R & D Institute UK	Runhua Chen, China Academy of Telecomm. Technology	Sandra Roger, Universitat Politècnica de València	Julian Cheng, University of British Columbia	Hamid Saeedi, Tarbiat Modares University	Hayssam Dahrouj, Effat University	Karim Seddik, American University in Cairo	Oussama Damen, University of Waterloo	Nima Seifi, Ericsson Research	Zhiguo Ding, Lancaster University	Cong Shen, University of Science and Technology of China	Qinghe Du, Xi'an Jiaotong University	Gokul Sridharan, Rutgers University	Lutfiye Durak-Ata, Yildiz Technical University	Leszek Szczecinski, INRS-EMT	Salman Durrani, The Australian National University	Chintha Tellambura, University of Alberta	Ozgur Ertug, Gazi University	Milos Tesanovic, Samsung Electronics R&D Institute UK	Carlo Fischione, KTH	Antti Tölli, University of Oulu	Ramy Gohary, Carleton University	Stefan Valentin, Huawei Technologies	David González G, Aalto University	Xianbin Wang, University of Western Ontario	Ekrum Hossain, University of Manitoba	Joerg Widmer, IMDEA Networks Institute	Kianoush Hosseini, Qualcomm Inc.	Jingxian Wu, University of Arkansas	Salama Ikki, Lakehead University	Xiaodong Xu, Beijing Univ. of Posts and Telecommunications	Hazer Inaltekin, Antalya International University	Yang Yi, University of Kansas	Omneya Issa, Communications Research Centre Canada	Di Yuan, Linköping University	Gunes Karabulut Kurt, Istanbul Technical University	Wolfgang Zirwas, Nokia Siemens Networks GmbH&CoKG	Mehmet Kemal Karakayali, Bell Labs, Alcatel-Lucent	Yaning Zou, Technische Universität Dresden	
Abdulkareem Adinoyi, Carleton University	Witold Krzymieñ, University of Alberta / TRILabs																																																																
Raviraj Adve, University of Toronto	Michel Kulhandjian, State University of New York at Buffalo																																																																
İbrahim Altunbaş, Istanbul Technical University	Yicheng Lin, University of Toronto																																																																
Sergey Andreev, Tampere University of Technology	Liang Liu, University of Toronto																																																																
Imran Ansari, Texas A&M University at Qatar (TAMUQ)	Liangping Ma, InterDigital																																																																
Erdem Bala, InterDigital	Behrooz Makki, Chalmers University of Technology																																																																
Anantharaman Balasubramanian, Interdigital Communications	Nicholas Mastronarde, University at Buffalo																																																																
Hadi Baligh, Huawei Technologies Canada co. Ltd.	Hani Mehrpouyan, Boise State University																																																																
Federico Boccardi, Ofcom	Keivan Navaie, Lancaster University																																																																
Shengrong Bu, University of Glasgow	Apostolos Papatthassiou, Intel Corporation																																																																
Daniel Calabuig, Universidad Politecnica de Valencia	Nikolaos Pappas, Linköping University																																																																
Houda Chafnaji, INPT Rabat	Benoit Pelletier, InterDigital Canada																																																																
Rong-Rong Chen, University of Utah	Yinan Qi, Samsung R & D Institute UK																																																																
Runhua Chen, China Academy of Telecomm. Technology	Sandra Roger, Universitat Politècnica de València																																																																
Julian Cheng, University of British Columbia	Hamid Saeedi, Tarbiat Modares University																																																																
Hayssam Dahrouj, Effat University	Karim Seddik, American University in Cairo																																																																
Oussama Damen, University of Waterloo	Nima Seifi, Ericsson Research																																																																
Zhiguo Ding, Lancaster University	Cong Shen, University of Science and Technology of China																																																																
Qinghe Du, Xi'an Jiaotong University	Gokul Sridharan, Rutgers University																																																																
Lutfiye Durak-Ata, Yildiz Technical University	Leszek Szczecinski, INRS-EMT																																																																
Salman Durrani, The Australian National University	Chintha Tellambura, University of Alberta																																																																
Ozgur Ertug, Gazi University	Milos Tesanovic, Samsung Electronics R&D Institute UK																																																																
Carlo Fischione, KTH	Antti Tölli, University of Oulu																																																																
Ramy Gohary, Carleton University	Stefan Valentin, Huawei Technologies																																																																
David González G, Aalto University	Xianbin Wang, University of Western Ontario																																																																
Ekrum Hossain, University of Manitoba	Joerg Widmer, IMDEA Networks Institute																																																																
Kianoush Hosseini, Qualcomm Inc.	Jingxian Wu, University of Arkansas																																																																
Salama Ikki, Lakehead University	Xiaodong Xu, Beijing Univ. of Posts and Telecommunications																																																																
Hazer Inaltekin, Antalya International University	Yang Yi, University of Kansas																																																																
Omneya Issa, Communications Research Centre Canada	Di Yuan, Linköping University																																																																
Gunes Karabulut Kurt, Istanbul Technical University	Wolfgang Zirwas, Nokia Siemens Networks GmbH&CoKG																																																																
Mehmet Kemal Karakayali, Bell Labs, Alcatel-Lucent	Yaning Zou, Technische Universität Dresden																																																																
Important Dates																																																																	
<p>Full Paper Submission: 1 July 2016, 11:59 pm (NYT)</p> <p>Acceptance Notification: 1 September 2016, 11:59 pm (NYT)</p> <p>Camera-Ready Submission: 1 October 2016, 11:59 pm (NYT)</p> <p>Workshop: 4 December 2016</p> <p>Submit papers using EDAS: https://edas.info/N22545</p> <p>Authors should follow Globecom submission guidelines (maximum 6 pages).</p>																																																																	